

## **Description**

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS(ON)}}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

# **Application**

- DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

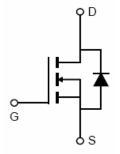
### **General Features**

- $V_{DS}$  =85V, $I_D$  =95A  $R_{DS(ON)}$ =5.4m $\Omega$  , typical (TO-220)@  $V_{GS}$ =10V  $R_{DS(ON)}$ =5.2m $\Omega$  , typical (TO-263)@  $V_{GS}$ =10V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating





TO-263



Schematic Diagram

### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST08N052-TC	VST08N052	TO-220C	-	-	-
VST08N052-T3	VST08N052	TO-263	-	-	-

## Absolute Maximum Ratings (T<sub>C</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	85	V	
Gate-Source Voltage	V <sub>G</sub> s	±20	V	
Drain Current-Continuous	I <sub>D</sub>	95	А	
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100°C)	70	Α	
Pulsed Drain Current	I <sub>DM</sub>	380	Α	
Maximum Power Dissipation	P <sub>D</sub>	125	W	
Derating factor		0.83	W/℃	
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	599	mJ	
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 175	°C	



# **Thermal Characteristic**

Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup>	$R_{ heta JC}$	1.2	°C/W	
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Electrical Characteristics (T<sub>C</sub>=25°Cunless otherwise noted)

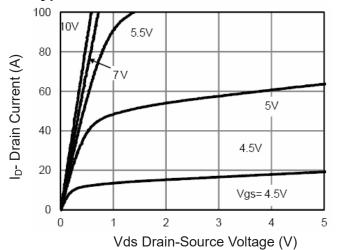
Parameter	Symbol	bol Condition		Min	Тур	Max	Unit
Off Characteristics				•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA		85		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =85V,V <sub>GS</sub> =0V		-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V		-	-	±100	nA
On Characteristics (Note 3)							
Gate Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA		2.0	3.0	4.0	V
Dunin Course On Chata Basistan	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =45A	TO-220	-	5.4	5.8	mΩ
Drain-Source On-State Resistance			TO-263		5.2	5.8	mΩ
Forward Transconductance	<b>g</b> FS	$V_{DS}=5V,I_{D}=$	V,I <sub>D</sub> =45A		60	-	S
Dynamic Characteristics (Note4)				•			
Input Capacitance	C <sub>lss</sub>	- V <sub>DS</sub> =40V,V <sub>GS</sub> =0V, - F=1.0MHz		-	3550	-	PF
Output Capacitance	Coss			-	540	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>			-	22	-	PF
Switching Characteristics (Note 4)				•	•		
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{DD}$ =40V, $I_{D}$ =45A $V_{GS}$ =10V, $R_{G}$ =1.6 $\Omega$		-	14.5	-	nS
Turn-on Rise Time	t <sub>r</sub>			-	12	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>			-	35	-	nS
Turn-Off Fall Time	t <sub>f</sub>			-	13	-	nS
Total Gate Charge	Qg	- V <sub>DS</sub> =40V,I <sub>D</sub> =45A, - V <sub>GS</sub> =10V		-	67	-	nC
Gate-Source Charge	Q <sub>gs</sub>			-	20		nC
Gate-Drain Charge	$Q_{gd}$			-	20		nC
Drain-Source Diode Characteristics					•		
Diode Forward Voltage (Note 3)	$V_{SD}$	V <sub>GS</sub> =0V,I <sub>S</sub> =45A		-		1.2	V
Diode Forward Current (Note 2)	Is			-	-	95	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = I <sub>S</sub>		-	66	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$		-	140	-	nC

### Notes:

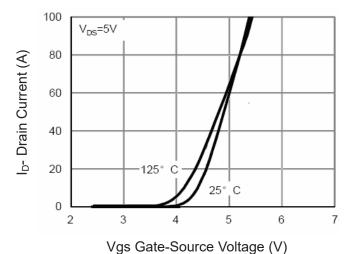
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}\text{C}$  ,VDD=40V,VG=10V,L=0.5mH,Rg=25 $\Omega$



## **Typical Electrical and Thermal Characteristics**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

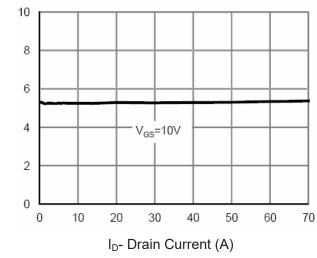


Figure 3 Rdson- Drain Current

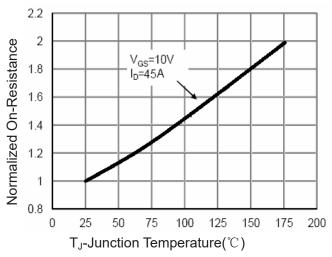


Figure 4 Rdson-Junction Temperature

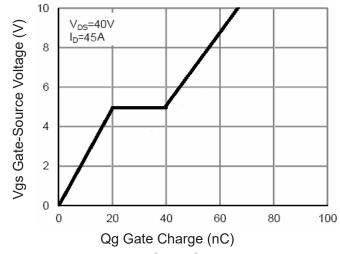


Figure 5 Gate Charge

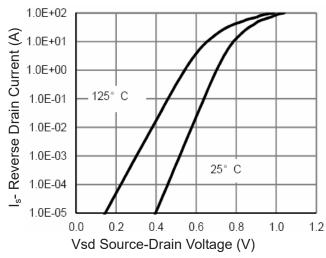


Figure 6 Source- Drain Diode Forward



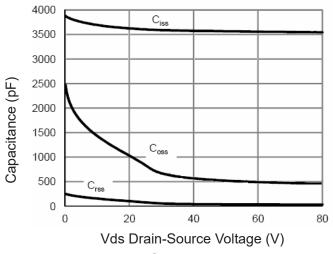


Figure 7 Capacitance vs Vds

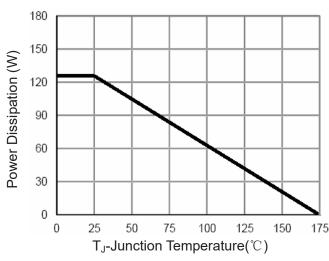


Figure 9 Power De-rating

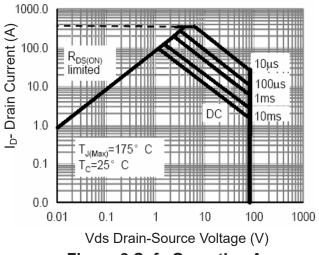


Figure 8 Safe Operation Area

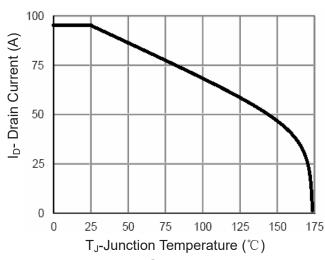


Figure 10 Current De-rating

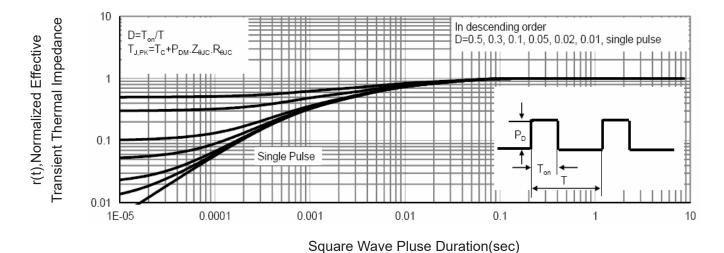


Figure 11 Normalized Maximum Transient Thermal Impedance